

200V N-Channel Enhancement Mode Power MOSFET

Description

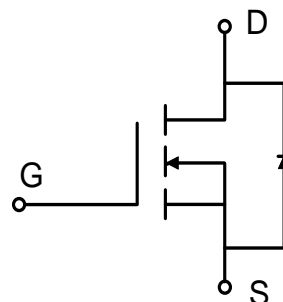
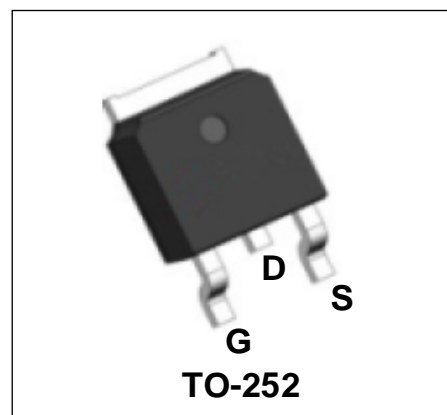
WMO18N20T2 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- $V_{DS} = 200V$, $I_D = 18A$
 $R_{DS(on)} < 130m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(on)} < 150m\Omega$ @ $V_{GS} = 4.5V$
- High Speed Power Smooth Switching, Logic Level
- Low Gate Charge
- 100% EAS Guaranteed

Applications

- DC/DC Converter
- LED Backlighting
- Motor Control



Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	200	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ¹	$T_C = 25^\circ C$	I_D	18	A
	$T_C = 100^\circ C$		11.7	
Pulsed Drain Current ²		I_{DM}	40	A
Single Pulse Avalanche Energy ³		EAS	5	mJ
Avalanche Current		I_{AS}	10	A
Total Power Dissipation ³	$T_C = 25^\circ C$	P_D	83	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	63	$^\circ C/W$
Thermal Resistance from Junction-to-Case ¹	$R_{\theta JC}$	1.5	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	200	-	-	V
Gate-body Leakage current		I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T _J =25℃	I _{DSS}	V _{DS} = 200V, V _{GS} = 0V	-	-	1	μA
	T _J =55℃			-	-	100	
Gate-Threshold Voltage		V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	2	3	V
Drain-Source On-Resistance ²		R _{DS(on)}	V _{GS} = 10V, I _D = 6A	-	96	130	mΩ
			V _{GS} = 4.5V, I _D = 4A	-	105	150	
Forward Transconductance		g _{fs}	V _{DS} = 5V, I _D = 20A	-	18	-	S
Dynamic Characteristics							
Input Capacitance		C _{iss}	V _{GS} =0V, V _{DS} = 100V, f =1MHz	-	534	-	pF
Output Capacitance		C _{oss}		-	30	-	
Reverse Transfer Capacitance		C _{rss}		-	7	-	
Switching Characteristics							
Gate Resistance		R _g	V _{DS} = 0V, V _{GS} =0V, f =1MHz	-	4.7	-	Ω
Total Gate Charge		Q _g	V _{GS} = 4.5V, V _{DS} = 100V, I _D = 5A	-	7.2	-	nC
Total Gate Charge		Q _g	V _{GS} = 10V, V _{DS} = 100V, I _D = 5A	-	11	-	
Gate-Source Charge		Q _{gs}		-	2.2	-	
Gate-Drain Charge		Q _{gd}		-	3.8	-	
Turn-On Delay Time		t _{d(on)}	V _{GS} = 10V, V _{DS} = 100V, R _G = 10Ω, I _D = 5A	-	11	-	nS
Rise Time		t _r		-	6	-	
Turn-Off Delay Time		t _{d(off)}		-	15	-	
Fall Time		t _f		-	4.8	-	
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²		V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1.2	V
Continuous Source Current ^{1,5}		I _S	V _G =V _D =0V, Force Current	-	-	18	A

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD} = 50V, V_{GS} = 10V, L = 0.1mH, I_{AS} = 10A$
4. The power dissipation is limited by 150°C junction temperature
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

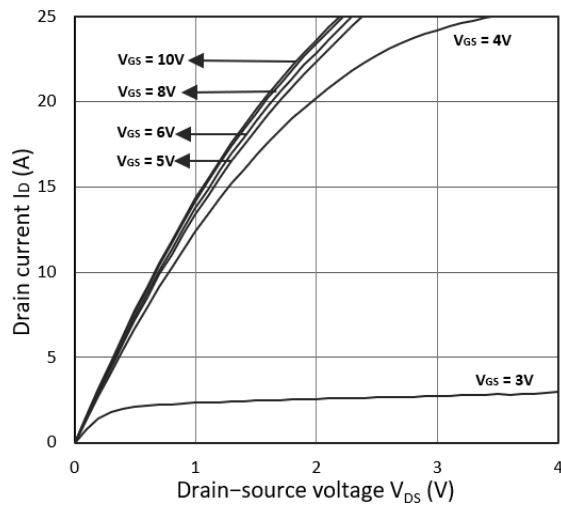


Figure 1. Output Characteristics

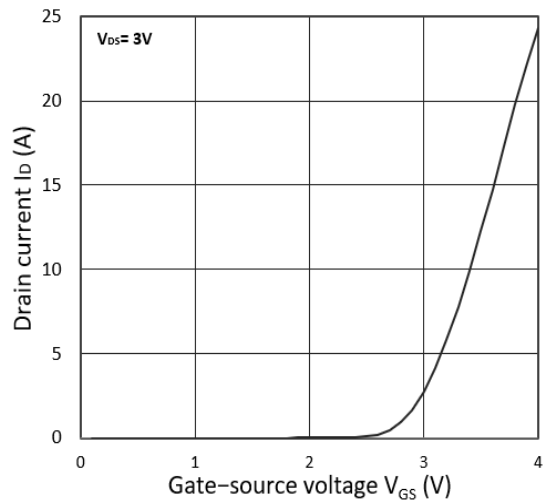


Figure 2. Transfer Characteristics

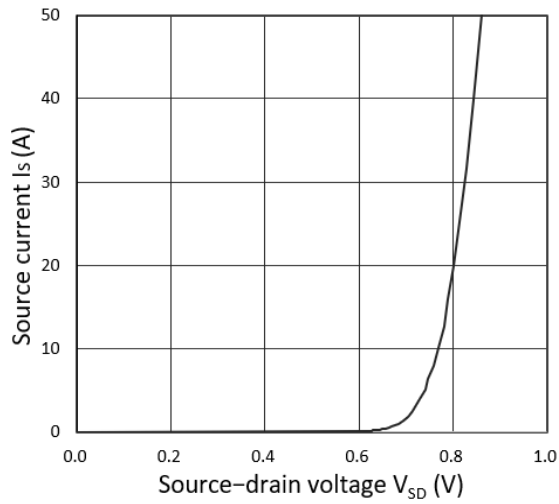


Figure 3. Forward Characteristics of Reverse

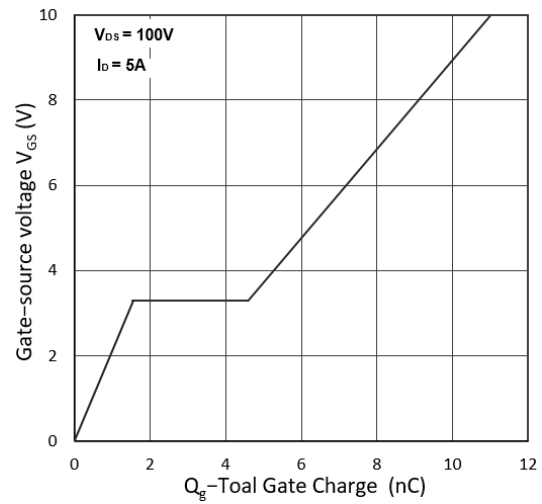
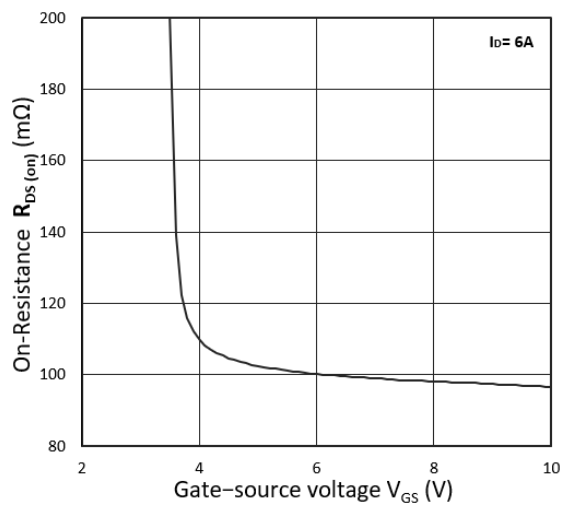
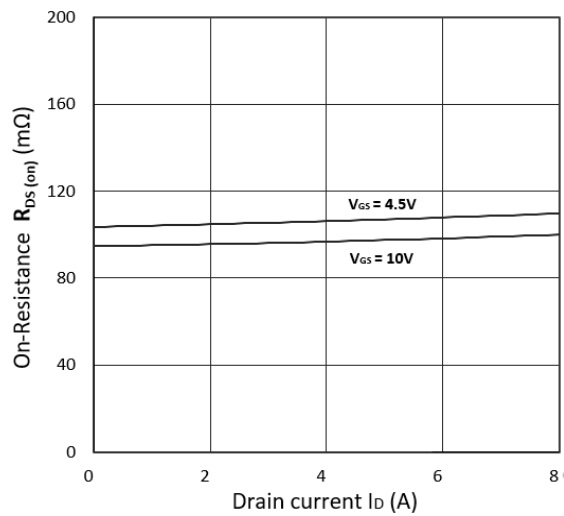


Figure 4. Gate Charge Characteristics

Figure 5. $R_{DS(ON)}$ vs. V_{GS} Figure 6. $R_{DS(ON)}$ vs. I_D

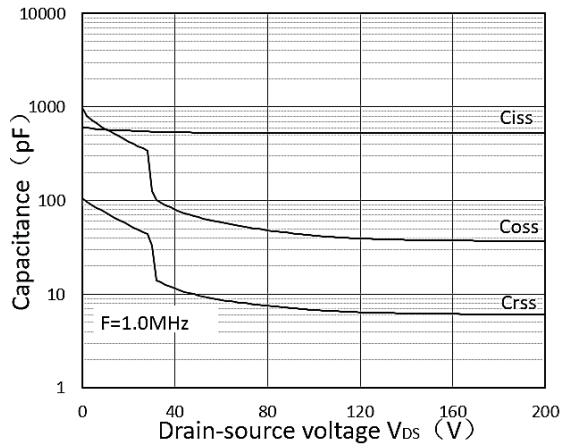


Figure 7. Capacitance Characteristics

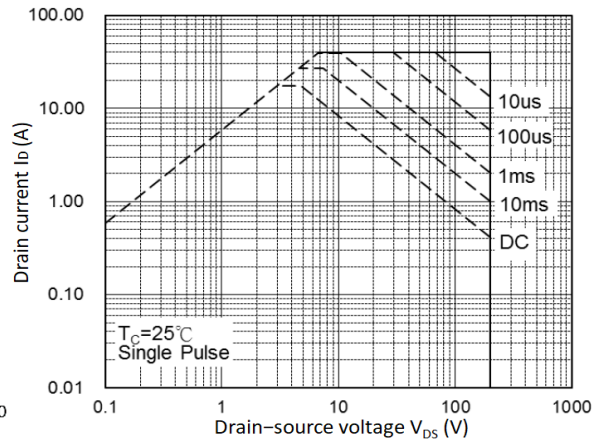


Figure 8. Safe Operating Area

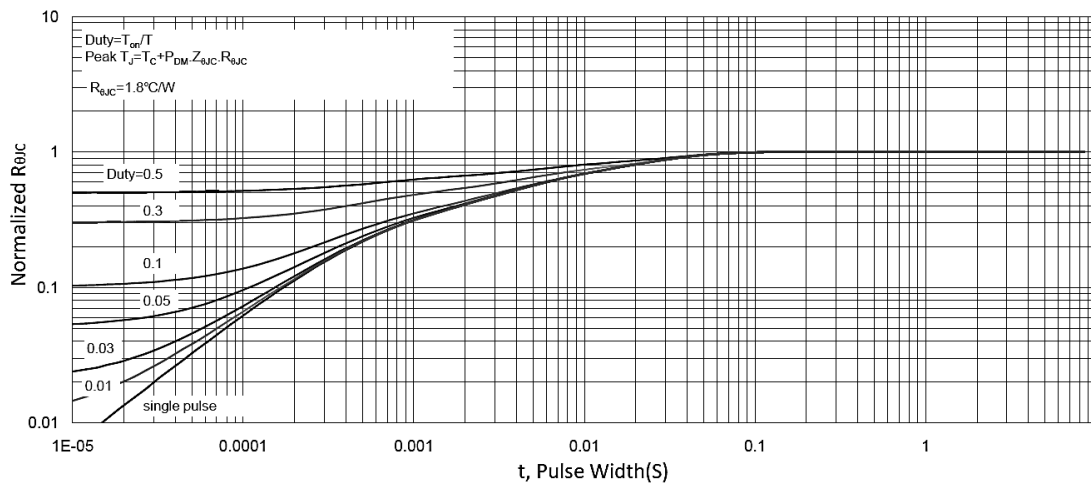


Figure 9. Normalized Maximum Transient Thermal Impedance

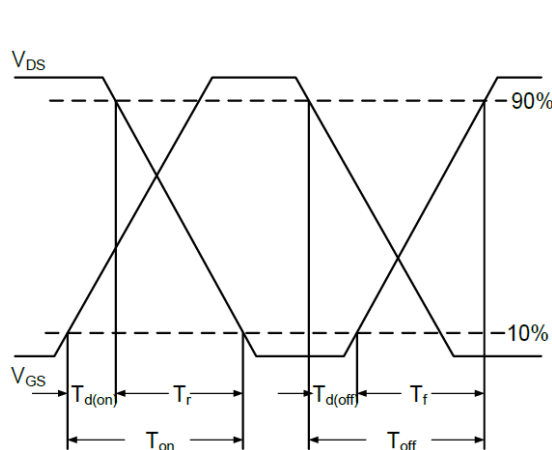
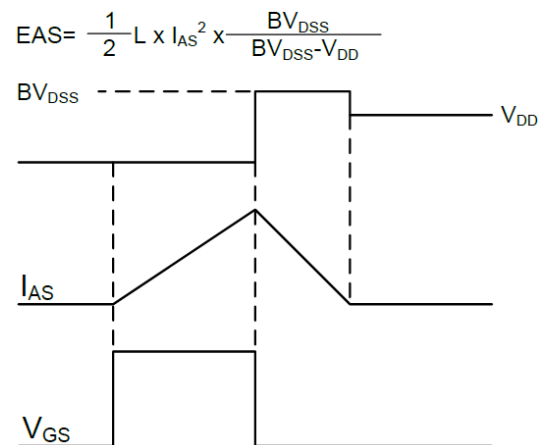
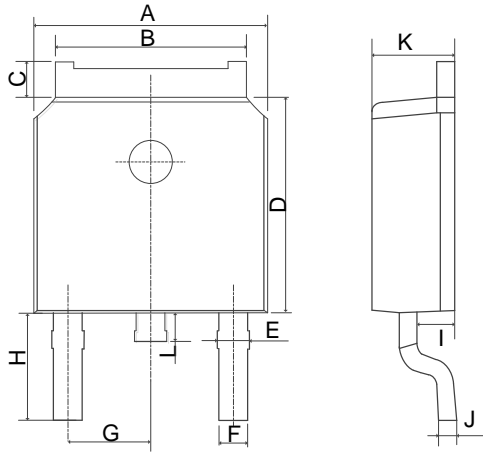


Figure 10. Switching Time Waveform

Figure 11. Unclamped Inductive Switching
Waveform

$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Mechanical Dimensions for TO-252



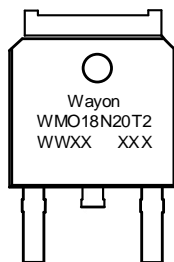
COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	2.90REF	
I	0.85	1.17
J	0.51REF	
K	2.10	2.50
L	0.40	1.00

Ordering Information

Part	Package	Marking	Packing method
WMO18N20T2	TO-252	WMO18N20T2	Tape and Reel

Marking Information



WMO18N20T2 = Device code

WWXX XXX= Date code

Contact Information

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